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What is "[Embedded - Microcontrollers](#)"?

"[Embedded - Microcontrollers](#)" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

Applications of "[Embedded - Microcontrollers](#)"

Details

| | |
|----------------------------|---|
| Product Status | Active |
| Core Processor | R8C |
| Core Size | 16-Bit |
| Speed | 20MHz |
| Connectivity | I ² C, LINbus, SIO, SSU, UART/USART |
| Peripherals | POR, PWM, Voltage Detect, WDT |
| Number of I/O | 47 |
| Program Memory Size | 128KB (128K x 8) |
| Program Memory Type | FLASH |
| EEPROM Size | 4K x 8 |
| RAM Size | 10K x 8 |
| Voltage - Supply (Vcc/Vdd) | 1.8V ~ 5.5V |
| Data Converters | A/D 12x10b; D/A 2x8b |
| Oscillator Type | Internal |
| Operating Temperature | -20°C ~ 85°C (TA) |
| Mounting Type | Surface Mount |
| Package / Case | 52-LQFP |
| Supplier Device Package | 52-LQFP (10x10) |
| Purchase URL | https://www.e-xfl.com/product-detail/renesas-electronics-america/r5f2135ccnfp-50 |

1.2 Product List

Table 1.3 lists Product List for R8C/35C Group, and Figure 1.1 shows a Part Number, Memory Size, and Package of R8C/35C Group.

Table 1.3 Product List for R8C/35C Group

Current of Aug 2010

| Part No. | ROM Capacity | | RAM Capacity | Package Type | Remarks |
|--------------|--------------|-------------|--------------|--------------|-----------|
| | Program ROM | Data flash | | | |
| R5F21354CNFP | 16 Kbytes | 1 Kbyte × 4 | 1.5 Kbytes | PLQP0052JA-A | N version |
| R5F21355CNFP | 24 Kbytes | 1 Kbyte × 4 | 2 Kbytes | PLQP0052JA-A | |
| R5F21356CNFP | 32 Kbytes | 1 Kbyte × 4 | 2.5 Kbytes | PLQP0052JA-A | |
| R5F21357CNFP | 48 Kbytes | 1 Kbyte × 4 | 4 Kbytes | PLQP0052JA-A | |
| R5F21358CNFP | 64 Kbytes | 1 Kbyte × 4 | 6 Kbytes | PLQP0052JA-A | |
| R5F2135ACNFP | 96 Kbytes | 1 Kbyte × 4 | 8 Kbytes | PLQP0052JA-A | |
| R5F2135CCNFP | 128 Kbytes | 1 Kbyte × 4 | 10 Kbytes | PLQP0052JA-A | |
| R5F21354CDFP | 16 Kbytes | 1 Kbyte × 4 | 1.5 Kbytes | PLQP0052JA-A | D version |
| R5F21355CDFP | 24 Kbytes | 1 Kbyte × 4 | 2 Kbytes | PLQP0052JA-A | |
| R5F21356CDFP | 32 Kbytes | 1 Kbyte × 4 | 2.5 Kbytes | PLQP0052JA-A | |
| R5F21357CDFP | 48 Kbytes | 1 Kbyte × 4 | 4 Kbytes | PLQP0052JA-A | |
| R5F21358CDFP | 64 Kbytes | 1 Kbyte × 4 | 6 Kbytes | PLQP0052JA-A | |
| R5F2135ACDFP | 96 Kbytes | 1 Kbyte × 4 | 8 Kbytes | PLQP0052JA-A | |
| R5F2135CCDFP | 128 Kbytes | 1 Kbyte × 4 | 10 Kbytes | PLQP0052JA-A | |

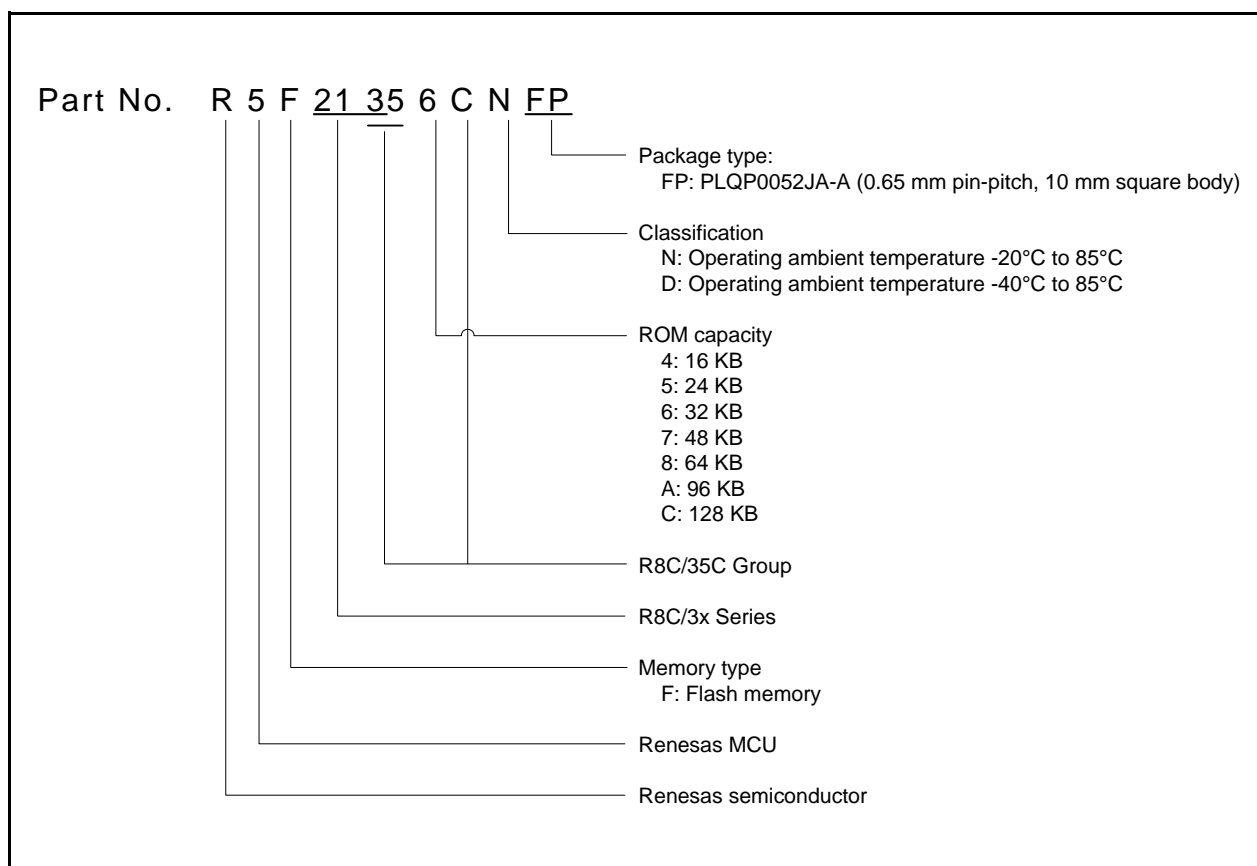


Figure 1.1 Part Number, Memory Size, and Package of R8C/35C Group

1.3 Block Diagram

Figure 1.2 shows a Block Diagram.

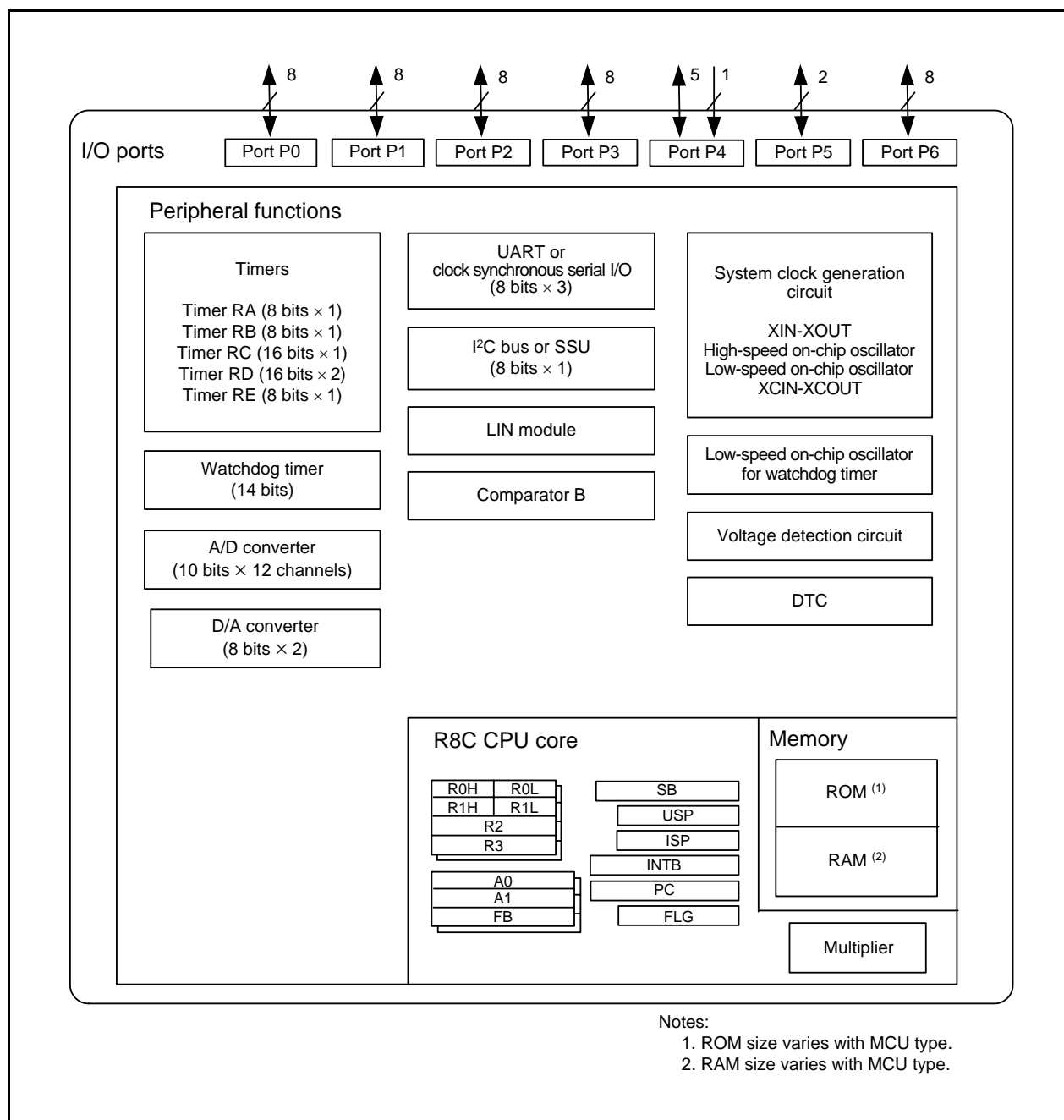


Figure 1.2 Block Diagram

1.5 Pin Functions

Tables 1.6 and 1.7 list Pin Functions.

Table 1.6 Pin Functions (1)

| Item | Pin Name | I/O Type | Description |
|---|--|----------|---|
| Power supply input | VCC, VSS | – | Apply 1.8 V to 5.5 V to the VCC pin. Apply 0 V to the VSS pin. |
| Analog power supply input | AVCC, AVSS | – | Power supply for the A/D converter. Connect a capacitor between AVCC and AVSS. |
| Reset input | $\overline{\text{RESET}}$ | I | Input “L” on this pin resets the MCU. |
| MODE | MODE | I | Connect this pin to VCC via a resistor. |
| XIN clock input | XIN | I | These pins are provided for XIN clock generation circuit I/O. Connect a ceramic resonator or a crystal oscillator between the XIN and XOUT pins ⁽¹⁾ . To use an external clock, input it to the XOUT pin and leave the XIN pin open. |
| XIN clock output | XOUT | I/O | |
| XCIN clock input | XCIN | I | These pins are provided for XCIN clock generation circuit I/O. Connect a crystal oscillator between the XCIN and XCOU pins ⁽¹⁾ . To use an external clock, input it to the XCIN pin and leave the XCOU pin open. |
| XCIN clock output | XCOU | O | |
| $\overline{\text{INT}}$ interrupt input | $\overline{\text{INT0}}$ to $\overline{\text{INT4}}$ | I | $\overline{\text{INT}}$ interrupt input pins. $\overline{\text{INT0}}$ is timer RB, RC and RD input pin. |
| Key input interrupt | $\overline{\text{KI0}}$ to $\overline{\text{KI3}}$ | I | Key input interrupt input pins |
| Timer RA | TRAIO | I/O | Timer RA I/O pin |
| | TRA0 | O | Timer RA output pin |
| Timer RB | TRBO | O | Timer RB output pin |
| Timer RC | TRCLK | I | External clock input pin |
| | TRCTR | I | External trigger input pin |
| | TRCIOA, TRCIOB, TRCIO, TRCIOD | I/O | Timer RC I/O pins |
| Timer RD | TRDIOA0, TRDIOA1, TRDIOB0, TRDIOB1, TRDIOC0, TRDIOC1, TRDIOD0, TRDIOD1 | I/O | Timer RD I/O pins |
| | TRDCLK | I | External clock input pin |
| Timer RE | TREO | O | Divided clock output pin |
| Serial interface | CLK0, CLK1, CLK2 | I/O | Transfer clock I/O pins |
| | RXD0, RXD1, RXD2 | I | Serial data input pins |
| | TXD0, TXD1, TXD2 | O | Serial data output pins |
| | $\overline{\text{CTS2}}$ | I | Transmission control input pin |
| | $\overline{\text{RTS2}}$ | O | Reception control output pin |
| | SCL2 | I/O | I ² C mode clock I/O pin |
| | SDA2 | I/O | I ² C mode data I/O pin |
| I ² C bus | SCL | I/O | Clock I/O pin |
| | SDA | I/O | Data I/O pin |
| SSU | SSI | I/O | Data I/O pin |
| | $\overline{\text{SCS}}$ | I/O | Chip-select signal I/O pin |
| | SSCK | I/O | Clock I/O pin |
| | SSO | I/O | Data I/O pin |

I: Input O: Output I/O: Input and output

Note:

1. Refer to the oscillator manufacturer for oscillation characteristics.

Table 1.7 Pin Functions (2)

| Item | Pin Name | I/O Type | Description |
|-------------------------|--|----------|--|
| Reference voltage input | VREF | I | Reference voltage input pin to A/D converter and D/A converter |
| A/D converter | AN0 to AN11 | I | Analog input pins to A/D converter |
| | ADTRG | I | A/D external trigger input pin |
| D/A converter | DA0, DA1 | O | D/A converter output pins |
| Comparator B | IVCMP1, IVCMP3 | I | Comparator B analog voltage input pins |
| | IVREF1, IVREF3 | I | Comparator B reference voltage input pins |
| I/O port | P0_0 to P0_7, P1_0 to P1_7, P2_0 to P2_7, P3_0 to P3_7, P4_3 to P4_7, P5_6, P5_7, P6_0 to P6_7 | I/O | CMOS I/O ports. Each port has an I/O select direction register, allowing each pin in the port to be directed for input or output individually. Any port set to input can be set to use a pull-up resistor or not by a program. All ports can be used as LED drive ports. |
| Input port | P4_2 | I | Input-only port |

I: Input O: Output I/O: Input and output

2. Central Processing Unit (CPU)

Figure 2.1 shows the CPU Registers. The CPU contains 13 registers. R0, R1, R2, R3, A0, A1, and FB configure a register bank. There are two sets of register bank.

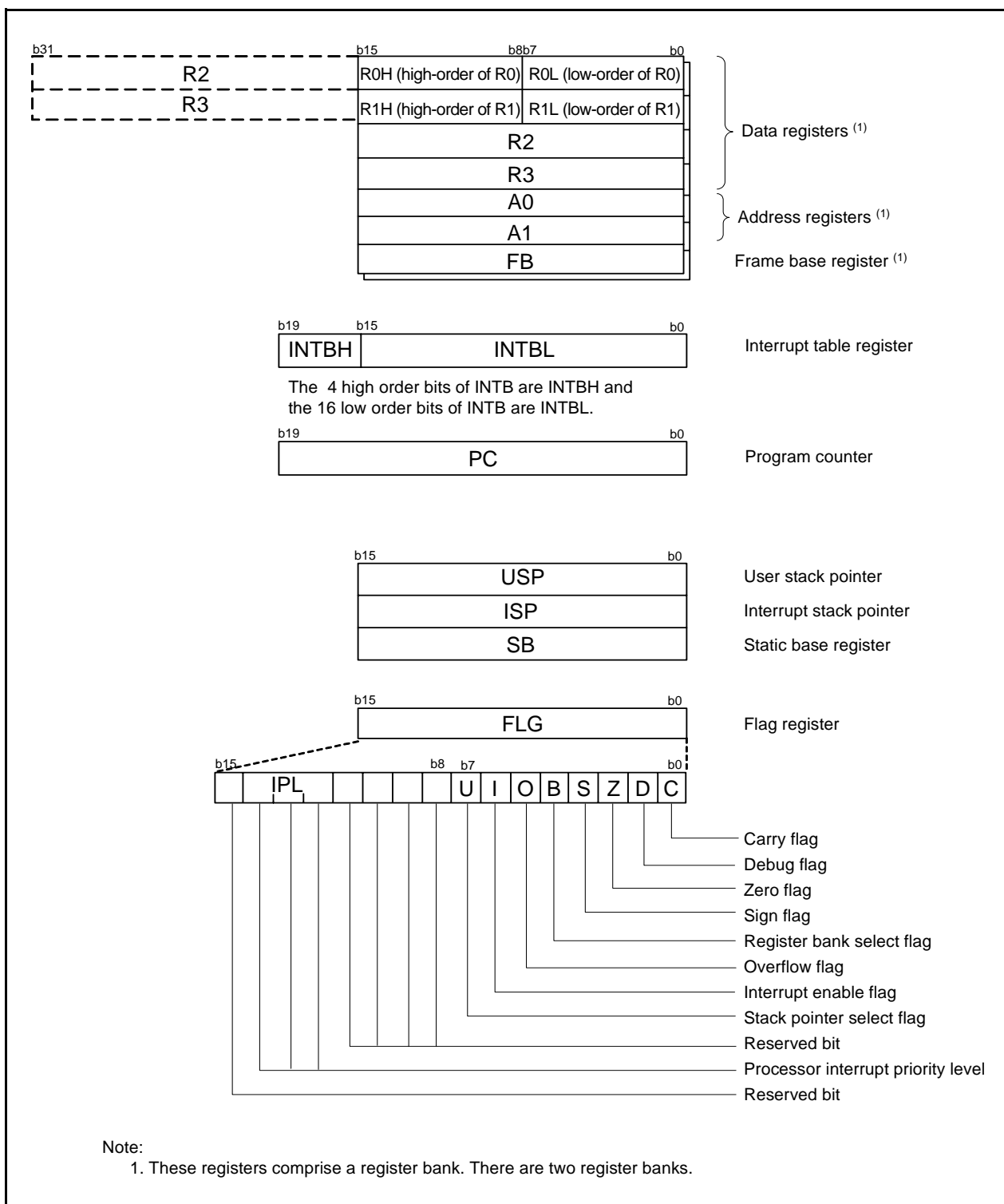


Figure 2.1 CPU Registers

Table 4.5 SFR Information (5) (1)

| Address | Register | Symbol | After Reset |
|---------|---|---------|-------------|
| 0100h | Timer RA Control Register | TRACR | 00h |
| 0101h | Timer RA I/O Control Register | TRAIOC | 00h |
| 0102h | Timer RA Mode Register | TRAMR | 00h |
| 0103h | Timer RA Prescaler Register | TRAPRE | FFh |
| 0104h | Timer RA Register | TRA | FFh |
| 0105h | LIN Control Register 2 | LINCR2 | 00h |
| 0106h | LIN Control Register | LINCR | 00h |
| 0107h | LIN Status Register | LINST | 00h |
| 0108h | Timer RB Control Register | TRBCR | 00h |
| 0109h | Timer RB One-Shot Control Register | TRBOCR | 00h |
| 010Ah | Timer RB I/O Control Register | TRBIOC | 00h |
| 010Bh | Timer RB Mode Register | TRBMR | 00h |
| 010Ch | Timer RB Prescaler Register | TRBPRE | FFh |
| 010Dh | Timer RB Secondary Register | TRBSC | FFh |
| 010Eh | Timer RB Primary Register | TRBPR | FFh |
| 010Fh | | | |
| 0110h | | | |
| 0111h | | | |
| 0112h | | | |
| 0113h | | | |
| 0114h | | | |
| 0115h | | | |
| 0116h | | | |
| 0117h | | | |
| 0118h | Timer RE Second Data Register / Counter Data Register | TRESEC | 00h |
| 0119h | Timer RE Minute Data Register / Compare Data Register | TREMIN | 00h |
| 011Ah | Timer RE Hour Data Register | TREHR | 00h |
| 011Bh | Timer RE Day of Week Data Register | TREWK | 00h |
| 011Ch | Timer RE Control Register 1 | TRECR1 | 00h |
| 011Dh | Timer RE Control Register 2 | TRECR2 | 00h |
| 011Eh | Timer RE Count Source Select Register | TRECSR | 00001000b |
| 011Fh | | | |
| 0120h | Timer RC Mode Register | TRCMR | 01001000b |
| 0121h | Timer RC Control Register 1 | TRCCR1 | 00h |
| 0122h | Timer RC Interrupt Enable Register | TRCIER | 01110000b |
| 0123h | Timer RC Status Register | TRCSR | 01110000b |
| 0124h | Timer RC I/O Control Register 0 | TRCIOR0 | 10001000b |
| 0125h | Timer RC I/O Control Register 1 | TRCIOR1 | 10001000b |
| 0126h | Timer RC Counter | TRC | 00h |
| 0127h | | | 00h |
| 0128h | Timer RC General Register A | TRCGRA | FFh |
| 0129h | | | FFh |
| 012Ah | Timer RC General Register B | TRCGRB | FFh |
| 012Bh | | | FFh |
| 012Ch | Timer RC General Register C | TRCGRC | FFh |
| 012Dh | | | FFh |
| 012Eh | Timer RC General Register D | TRCGRD | FFh |
| 012Fh | | | FFh |
| 0130h | Timer RC Control Register 2 | TRCCR2 | 00011000b |
| 0131h | Timer RC Digital Filter Function Select Register | TRCDF | 00h |
| 0132h | Timer RC Output Master Enable Register | TRCOER | 01111111b |
| 0133h | Timer RC Trigger Control Register | TRCADCR | 00h |
| 0134h | | | |
| 0135h | Timer RD Control Expansion Register | TRDECR | 00h |
| 0136h | Timer RD Trigger Control Register | TRDADC | 00h |
| 0137h | Timer RD Start Register | TRDSTR | 11111100b |
| 0138h | Timer RD Mode Register | TRDMR | 00001110b |
| 0139h | Timer RD PWM Mode Register | TRDPMR | 10001000b |
| 013Ah | Timer RD Function Control Register | TRDFCR | 10000000b |
| 013Bh | Timer RD Output Master Enable Register 1 | TRDOER1 | FFh |
| 013Ch | Timer RD Output Master Enable Register 2 | TRDOER2 | 01111111b |
| 013Dh | Timer RD Output Control Register | TRDOCR | 00h |
| 013Eh | Timer RD Digital Filter Function Select Register 0 | TRDDF0 | 00h |
| 013Fh | Timer RD Digital Filter Function Select Register 1 | TRDDF1 | 00h |

Note:

1. The blank areas are reserved and cannot be accessed by users.

Table 4.6 SFR Information (6) (1)

| Address | Register | Symbol | After Reset |
|---------|---|----------|-------------|
| 0140h | Timer RD Control Register 0 | TRDCR0 | 00h |
| 0141h | Timer RD I/O Control Register A0 | TRDIOA0 | 10001000b |
| 0142h | Timer RD I/O Control Register C0 | TRDIORC0 | 10001000b |
| 0143h | Timer RD Status Register 0 | TRDSR0 | 11100000b |
| 0144h | Timer RD Interrupt Enable Register 0 | TRDIER0 | 11100000b |
| 0145h | Timer RD PWM Mode Output Level Control Register 0 | TRDPOCR0 | 11111000b |
| 0146h | Timer RD Counter 0 | TRD0 | 00h |
| 0147h | | | 00h |
| 0148h | Timer RD General Register A0 | TRDGRA0 | FFh |
| 0149h | | | FFh |
| 014Ah | Timer RD General Register B0 | TRDGRB0 | FFh |
| 014Bh | | | FFh |
| 014Ch | Timer RD General Register C0 | TRDGRC0 | FFh |
| 014Dh | | | FFh |
| 014Eh | Timer RD General Register D0 | TRDGRD0 | FFh |
| 014Fh | | | FFh |
| 0150h | Timer RD Control Register 1 | TRDCR1 | 00h |
| 0151h | Timer RD I/O Control Register A1 | TRDIOA1 | 10001000b |
| 0152h | Timer RD I/O Control Register C1 | TRDIORC1 | 10001000b |
| 0153h | Timer RD Status Register 1 | TRDSR1 | 11000000b |
| 0154h | Timer RD Interrupt Enable Register 1 | TRDIER1 | 11100000b |
| 0155h | Timer RD PWM Mode Output Level Control Register 1 | TRDPOCR1 | 11111000b |
| 0156h | Timer RD Counter 1 | TRD1 | 00h |
| 0157h | | | 00h |
| 0158h | Timer RD General Register A1 | TRDGRA1 | FFh |
| 0159h | | | FFh |
| 015Ah | Timer RD General Register B1 | TRDGRB1 | FFh |
| 015Bh | | | FFh |
| 015Ch | Timer RD General Register C1 | TRDGRC1 | FFh |
| 015Dh | | | FFh |
| 015Eh | Timer RD General Register D1 | TRDGRD1 | FFh |
| 015Fh | | | FFh |
| 0160h | UART1 Transmit/Receive Mode Register | U1MR | 00h |
| 0161h | UART1 Bit Rate Register | U1BRG | XXh |
| 0162h | UART1 Transmit Buffer Register | U1TB | XXh |
| 0163h | | | XXh |
| 0164h | UART1 Transmit/Receive Control Register 0 | U1C0 | 00001000b |
| 0165h | UART1 Transmit/Receive Control Register 1 | U1C1 | 00000010b |
| 0166h | UART1 Receive Buffer Register | U1RB | XXh |
| 0167h | | | XXh |
| 0168h | | | |
| 0169h | | | |
| 016Ah | | | |
| 016Bh | | | |
| 016Ch | | | |
| 016Dh | | | |
| 016Eh | | | |
| 016Fh | | | |
| 0170h | | | |
| 0171h | | | |
| 0172h | | | |
| 0173h | | | |
| 0174h | | | |
| 0175h | | | |
| 0176h | | | |
| 0177h | | | |
| 0178h | | | |
| 0179h | | | |
| 017Ah | | | |
| 017Bh | | | |
| 017Ch | | | |
| 017Dh | | | |
| 017Eh | | | |
| 017Fh | | | |

X: Undefined

Note:

1. The blank areas are reserved and cannot be accessed by users.

Table 4.7 SFR Information (7) ⁽¹⁾

| Address | Register | Symbol | After Reset |
|---------|---|---------------|-----------------------|
| 0180h | Timer RA Pin Select Register | TRASR | 00h |
| 0181h | Timer RB/RC Pin Select Register | TRBRCSR | 00h |
| 0182h | Timer RC Pin Select Register 0 | TRCPSR0 | 00h |
| 0183h | Timer RC Pin Select Register 1 | TRCPSR1 | 00h |
| 0184h | Timer RD Pin Select Register 0 | TRDPSR0 | 00h |
| 0185h | Timer RD Pin Select Register 1 | TRDPSR1 | 00h |
| 0186h | Timer Pin Select Register | TIMSR | 00h |
| 0187h | | | |
| 0188h | UART0 Pin Select Register | U0SR | 00h |
| 0189h | UART1 Pin Select Register | U1SR | 00h |
| 018Ah | UART2 Pin Select Register 0 | U2SR0 | 00h |
| 018Bh | UART2 Pin Select Register 1 | U2SR1 | 00h |
| 018Ch | SSU/IIC Pin Select Register | SSUICSR | 00h |
| 018Dh | | | |
| 018Eh | INT Interrupt Input Pin Select Register | INTSR | 00h |
| 018Fh | I/O Function Pin Select Register | PINSR | 00h |
| 0190h | | | |
| 0191h | | | |
| 0192h | | | |
| 0193h | SS Bit Counter Register | SSBR | 11111000b |
| 0194h | SS Transmit Data Register L / IIC bus Transmit Data Register ⁽²⁾ | SSTDR / ICDRT | FFh |
| 0195h | SS Transmit Data Register H ⁽²⁾ | SSTDRH | FFh |
| 0196h | SS Receive Data Register L / IIC bus Receive Data Register ⁽²⁾ | SSRDR / ICDRR | FFh |
| 0197h | SS Receive Data Register H ⁽²⁾ | SSRDRH | FFh |
| 0198h | SS Control Register H / IIC bus Control Register 1 ⁽²⁾ | SSCRH / ICCR1 | 00h |
| 0199h | SS Control Register L / IIC bus Control Register 2 ⁽²⁾ | SSCRL / ICCR2 | 01111101b |
| 019Ah | SS Mode Register / IIC bus Mode Register ⁽²⁾ | SSMR / ICMR | 00010000b / 00011000b |
| 019Bh | SS Enable Register / IIC bus Interrupt Enable Register ⁽²⁾ | SSER / ICIER | 00h |
| 019Ch | SS Status Register / IIC bus Status Register ⁽²⁾ | SSSR / ICSR | 00h / 0000X000b |
| 019Dh | SS Mode Register 2 / Slave Address Register ⁽²⁾ | SSMR2 / SAR | 00h |
| 019Eh | | | |
| 019Fh | | | |
| 01A0h | | | |
| 01A1h | | | |
| 01A2h | | | |
| 01A3h | | | |
| 01A4h | | | |
| 01A5h | | | |
| 01A6h | | | |
| 01A7h | | | |
| 01A8h | | | |
| 01A9h | | | |
| 01AAh | | | |
| 01ABh | | | |
| 01ACh | | | |
| 01ADh | | | |
| 01AEh | | | |
| 01AFh | | | |
| 01B0h | | | |
| 01B1h | | | |
| 01B2h | Flash Memory Status Register | FST | 10000X00b |
| 01B3h | | | |
| 01B4h | Flash Memory Control Register 0 | FMR0 | 00h |
| 01B5h | Flash Memory Control Register 1 | FMR1 | 00h |
| 01B6h | Flash Memory Control Register 2 | FMR2 | 00h |
| 01B7h | | | |
| 01B8h | | | |
| 01B9h | | | |
| 01BAh | | | |
| 01BBh | | | |
| 01BCh | | | |
| 01BDh | | | |
| 01BEh | | | |
| 01BFh | | | |

X: Undefined

Notes:

1. The blank areas are reserved and cannot be accessed by users.
2. Selectable by the IICSEL bit in the SSUICSR register.

Table 4.9 SFR Information (9) (1)

| Address | Register | Symbol | After Reset |
|---------|--------------------------|--------|-------------|
| 2C00h | DTC Transfer Vector Area | | XXh |
| 2C01h | DTC Transfer Vector Area | | XXh |
| 2C02h | DTC Transfer Vector Area | | XXh |
| 2C03h | DTC Transfer Vector Area | | XXh |
| 2C04h | DTC Transfer Vector Area | | XXh |
| 2C05h | DTC Transfer Vector Area | | XXh |
| 2C06h | DTC Transfer Vector Area | | XXh |
| 2C07h | DTC Transfer Vector Area | | XXh |
| 2C08h | DTC Transfer Vector Area | | XXh |
| 2C09h | DTC Transfer Vector Area | | XXh |
| 2C0Ah | DTC Transfer Vector Area | | XXh |
| : | DTC Transfer Vector Area | | XXh |
| : | DTC Transfer Vector Area | | XXh |
| 2C3Ah | DTC Transfer Vector Area | | XXh |
| 2C3Bh | DTC Transfer Vector Area | | XXh |
| 2C3Ch | DTC Transfer Vector Area | | XXh |
| 2C3Dh | DTC Transfer Vector Area | | XXh |
| 2C3Eh | DTC Transfer Vector Area | | XXh |
| 2C3Fh | DTC Transfer Vector Area | | XXh |
| 2C40h | DTC Control Data 0 | DTCD0 | XXh |
| 2C41h | | | XXh |
| 2C42h | | | XXh |
| 2C43h | | | XXh |
| 2C44h | | | XXh |
| 2C45h | | | XXh |
| 2C46h | | | XXh |
| 2C47h | | | XXh |
| 2C48h | DTC Control Data 1 | DTCD1 | XXh |
| 2C49h | | | XXh |
| 2C4Ah | | | XXh |
| 2C4Bh | | | XXh |
| 2C4Ch | | | XXh |
| 2C4Dh | | | XXh |
| 2C4Eh | | | XXh |
| 2C4Fh | | | XXh |
| 2C50h | DTC Control Data 2 | DTCD2 | XXh |
| 2C51h | | | XXh |
| 2C52h | | | XXh |
| 2C53h | | | XXh |
| 2C54h | | | XXh |
| 2C55h | | | XXh |
| 2C56h | | | XXh |
| 2C57h | | | XXh |
| 2C58h | DTC Control Data 3 | DTCD3 | XXh |
| 2C59h | | | XXh |
| 2C5Ah | | | XXh |
| 2C5Bh | | | XXh |
| 2C5Ch | | | XXh |
| 2C5Dh | | | XXh |
| 2C5Eh | | | XXh |
| 2C5Fh | | | XXh |
| 2C60h | DTC Control Data 4 | DTCD4 | XXh |
| 2C61h | | | XXh |
| 2C62h | | | XXh |
| 2C63h | | | XXh |
| 2C64h | | | XXh |
| 2C65h | | | XXh |
| 2C66h | | | XXh |
| 2C67h | | | XXh |
| 2C68h | DTC Control Data 5 | DTCD5 | XXh |
| 2C69h | | | XXh |
| 2C6Ah | | | XXh |
| 2C6Bh | | | XXh |
| 2C6Ch | | | XXh |
| 2C6Dh | | | XXh |
| 2C6Eh | | | XXh |
| 2C6Fh | | | XXh |

X: Undefined

Note:

1. The blank areas are reserved and cannot be accessed by users.

Table 4.10 SFR Information (10) (1)

| Address | Register | Symbol | After Reset |
|---------|---------------------|--------|-------------|
| 2C70h | DTC Control Data 6 | DTCD6 | XXh |
| 2C71h | | | XXh |
| 2C72h | | | XXh |
| 2C73h | | | XXh |
| 2C74h | | | XXh |
| 2C75h | | | XXh |
| 2C76h | | | XXh |
| 2C77h | | | XXh |
| 2C78h | DTC Control Data 7 | DTCD7 | XXh |
| 2C79h | | | XXh |
| 2C7Ah | | | XXh |
| 2C7Bh | | | XXh |
| 2C7Ch | | | XXh |
| 2C7Dh | | | XXh |
| 2C7Eh | | | XXh |
| 2C7Fh | | | XXh |
| 2C80h | DTC Control Data 8 | DTCD8 | XXh |
| 2C81h | | | XXh |
| 2C82h | | | XXh |
| 2C83h | | | XXh |
| 2C84h | | | XXh |
| 2C85h | | | XXh |
| 2C86h | | | XXh |
| 2C87h | | | XXh |
| 2C88h | DTC Control Data 9 | DTCD9 | XXh |
| 2C89h | | | XXh |
| 2C8Ah | | | XXh |
| 2C8Bh | | | XXh |
| 2C8Ch | | | XXh |
| 2C8Dh | | | XXh |
| 2C8Eh | | | XXh |
| 2C8Fh | | | XXh |
| 2C90h | DTC Control Data 10 | DTCD10 | XXh |
| 2C91h | | | XXh |
| 2C92h | | | XXh |
| 2C93h | | | XXh |
| 2C94h | | | XXh |
| 2C95h | | | XXh |
| 2C96h | | | XXh |
| 2C97h | | | XXh |
| 2C98h | DTC Control Data 11 | DTCD11 | XXh |
| 2C99h | | | XXh |
| 2C9Ah | | | XXh |
| 2C9Bh | | | XXh |
| 2C9Ch | | | XXh |
| 2C9Dh | | | XXh |
| 2C9Eh | | | XXh |
| 2C9Fh | | | XXh |
| 2CA0h | DTC Control Data 12 | DTCD12 | XXh |
| 2CA1h | | | XXh |
| 2CA2h | | | XXh |
| 2CA3h | | | XXh |
| 2CA4h | | | XXh |
| 2CA5h | | | XXh |
| 2CA6h | | | XXh |
| 2CA7h | | | XXh |
| 2CA8h | DTC Control Data 13 | DTCD13 | XXh |
| 2CA9h | | | XXh |
| 2CAAh | | | XXh |
| 2CABh | | | XXh |
| 2CACH | | | XXh |
| 2CADh | | | XXh |
| 2CAEh | | | XXh |
| 2CAFh | | | XXh |

X: Undefined

Note:

1. The blank areas are reserved and cannot be accessed by users.

Table 5.4 D/A Converter Characteristics

| Symbol | Parameter | Condition | Standard | | | Unit |
|------------|-------------------------------|-----------|----------|------|------|-----------|
| | | | Min. | Typ. | Max. | |
| — | Resolution | | — | — | 8 | Bit |
| — | Absolute accuracy | | — | — | 2.5 | LSB |
| t_{su} | Setup time | | — | — | 3 | μs |
| R_o | Output resistor | | — | 6 | — | $k\Omega$ |
| I_{Vref} | Reference power input current | (Note 2) | — | — | 1.5 | mA |

Notes:

1. $V_{CC}/AV_{CC} = V_{ref} = 2.7$ to 5.5 V and $T_{opr} = -20$ to $85^{\circ}C$ (N version) / -40 to $85^{\circ}C$ (D version), unless otherwise specified.
2. This applies when one D/A converter is used and the value of the DA_i register ($i = 0$ or 1) for the unused D/A converter is $00h$. The resistor ladder of the A/D converter is not included.

Table 5.5 Comparator B Electrical Characteristics

| Symbol | Parameter | Condition | Standard | | | Unit |
|-----------|---|----------------------------|----------|------|----------------|---------|
| | | | Min. | Typ. | Max. | |
| V_{ref} | $IVREF1$, $IVREF3$ input reference voltage | | 0 | — | $V_{CC} - 1.4$ | V |
| V_I | $IVCMP1$, $IVCMP3$ input voltage | | -0.3 | — | $V_{CC} + 0.3$ | V |
| — | Offset | | — | 5 | 100 | mV |
| t_d | Comparator output delay time ⁽²⁾ | $V_I = V_{ref} \pm 100$ mV | — | 0.1 | — | μs |
| I_{CMP} | Comparator operating current | $V_{CC} = 5.0$ V | — | 17.5 | — | μA |

Notes:

1. $V_{CC} = 2.7$ to 5.5 V, $T_{opr} = -20$ to $85^{\circ}C$ (N version) / -40 to $85^{\circ}C$ (D version), unless otherwise specified.
2. When the digital filter is disabled.

Table 5.6 Flash Memory (Program ROM) Electrical Characteristics

| Symbol | Parameter | Conditions | Standard | | | Unit |
|-------------------------------|--|----------------------------|----------------------|------|---------------------------|-------|
| | | | Min. | Typ. | Max. | |
| — | Program/erase endurance ⁽²⁾ | | 1,000 ⁽³⁾ | — | — | times |
| — | Byte program time | | — | 80 | 500 | μs |
| — | Block erase time | | — | 0.3 | — | s |
| t _d (SR-SUS) | Time delay from suspend request until suspend | | — | — | 5+CPU clock × 3 cycles | ms |
| — | Interval from erase start/restart until following suspend request | | 0 | — | — | μs |
| — | Time from suspend until erase restart | | — | — | 30+CPU clock × 1 cycle | μs |
| t _d (CMDRST-READY) | Time from when command is forcibly terminated until reading is enabled | | — | — | 30+CPU clock × 1 cycle | μs |
| — | Program, erase voltage | | 2.7 | — | 5.5 | V |
| — | Read voltage | | 1.8 | — | 5.5 | V |
| — | Program, erase temperature | | 0 | — | 60 | °C |
| — | Data hold time ⁽⁷⁾ | Ambient temperature = 55°C | 20 | — | — | year |

Notes:

1. V_{CC} = 2.7 to 5.5 V and T_{opr} = 0 to 60°C, unless otherwise specified.

2. Definition of programming/erasure endurance

The programming and erasure endurance is defined on a per-block basis.

If the programming and erasure endurance is n (n = 1,000), each block can be erased n times. For example, if 1,024 1-byte writes are performed to different addresses in block A, a 1 Kbyte block, and then the block is erased, the programming/erasure endurance still stands at one.

However, the same address must not be programmed more than once per erase operation (overwriting prohibited).

3. Endurance to guarantee all electrical characteristics after program and erase. (1 to Min. value can be guaranteed).

4. In a system that executes multiple programming operations, the actual erasure count can be reduced by writing to sequential addresses in turn so that as much of the block as possible is used up before performing an erase operation. For example, when programming groups of 16 bytes, the effective number of rewrites can be minimized by programming up to 128 groups before erasing them all in one operation. It is also advisable to retain data on the erasure endurance of each block and limit the number of erase operations to a certain number.

5. If an error occurs during block erase, attempt to execute the clear status register command, then execute the block erase command at least three times until the erase error does not occur.

6. Customers desiring program/erase failure rate information should contact their Renesas technical support representative.

7. The data hold time includes time that the power supply is off or the clock is not supplied.

Table 5.10 Voltage Detection 2 Circuit Electrical Characteristics

| Symbol | Parameter | Condition | Standard | | | Unit |
|---------|--|---|----------|------|------|------|
| | | | Min. | Typ. | Max. | |
| Vdet2 | Voltage detection level Vdet2_0 | At the falling of Vcc | 3.70 | 4.00 | 4.30 | V |
| — | Hysteresis width at the rising of Vcc in voltage detection 2 circuit | | — | 0.10 | — | V |
| — | Voltage detection 2 circuit response time ⁽²⁾ | At the falling of Vcc from 5 V to (Vdet2_0 – 0.1) V | — | 20 | 150 | μs |
| — | Voltage detection circuit self power consumption | VCA27 = 1, Vcc = 5.0 V | — | 1.7 | — | μA |
| td(E-A) | Waiting time until voltage detection circuit operation starts ⁽³⁾ | | — | — | 100 | μs |

Notes:

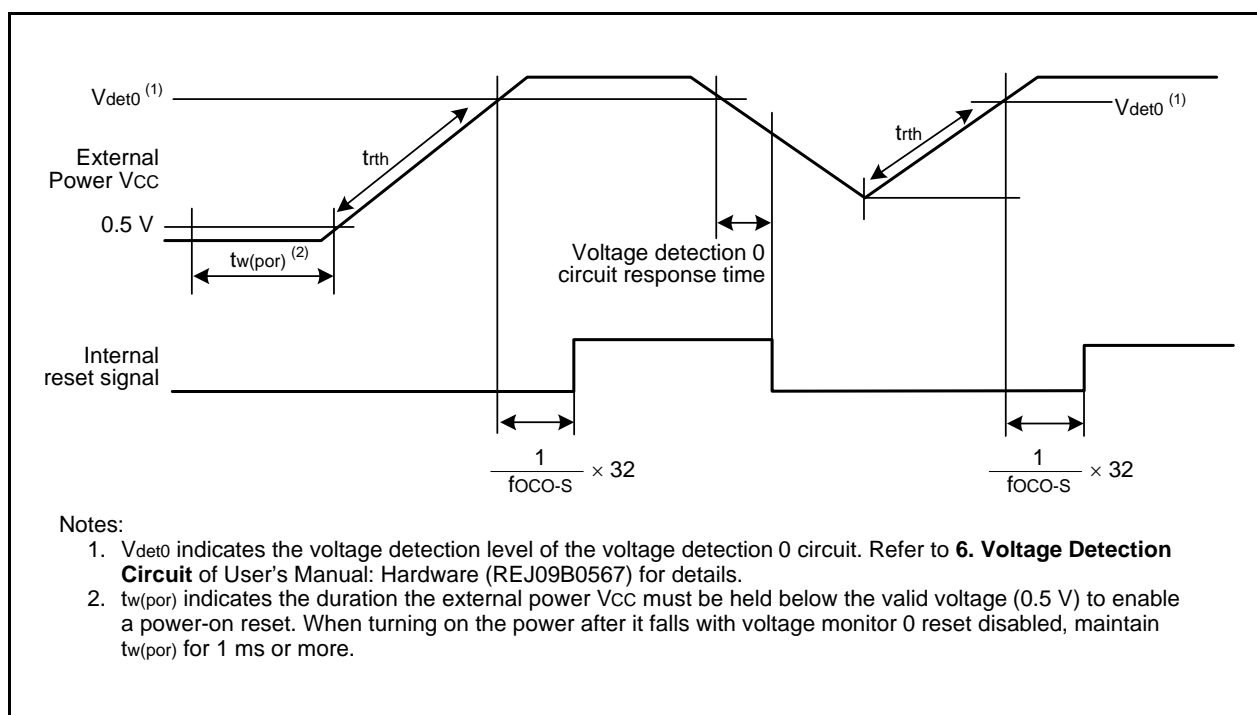
1. The measurement condition is Vcc = 1.8 V to 5.5 V and T_{opr} = –20 to 85°C (N version) / –40 to 85°C (D version).
2. Time until the voltage monitor 2 interrupt request is generated after the voltage passes Vdet2.
3. Necessary time until the voltage detection circuit operates after setting to 1 again after setting the VCA27 bit in the VCA2 register to 0.

Table 5.11 Power-on Reset Circuit (2)

| Symbol | Parameter | Condition | Standard | | | Unit |
|--------|----------------------------------|----------------|----------|------|--------|---------|
| | | | Min. | Typ. | Max. | |
| trth | External power Vcc rise gradient | ⁽¹⁾ | 0 | — | 50,000 | mV/msec |

Notes:

1. The measurement condition is T_{opr} = –20 to 85°C (N version) / –40 to 85°C (D version), unless otherwise specified.
2. To use the power-on reset function, enable voltage monitor 0 reset by setting the LVDAS bit in the OFS register to 0.

**Figure 5.3 Power-on Reset Circuit Electrical Characteristics**

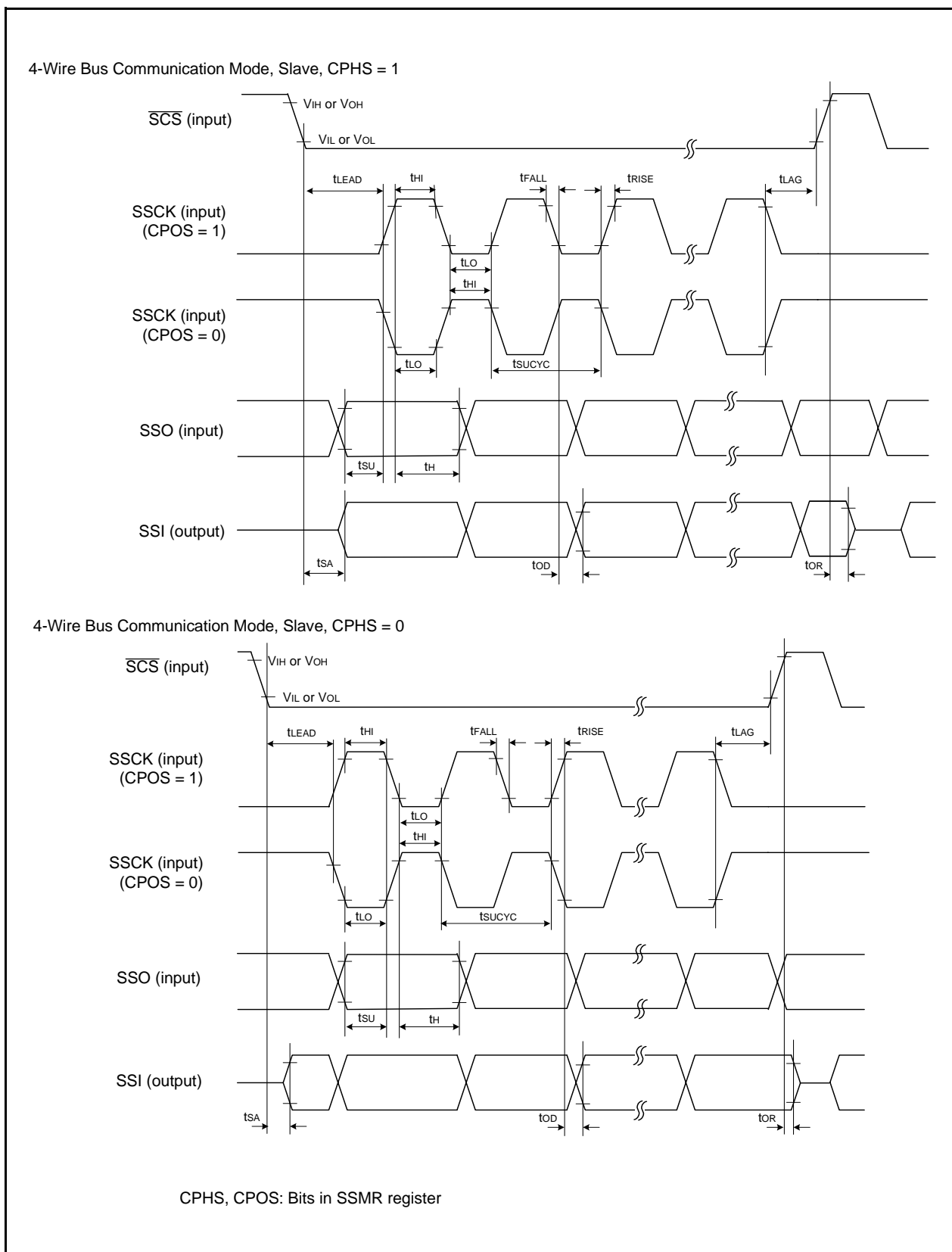


Figure 5.5 I/O Timing of Synchronous Serial Communication Unit (SSU) (Slave)

Table 5.17 Electrical Characteristics (1) [4.2 V ≤ Vcc ≤ 5.5 V]

| Symbol | Parameter | | Condition | | Standard | | | Unit |
|---------|---------------------|--|-------------------------------|---------------|-----------|------|------|------|
| | | | | | Min. | Typ. | Max. | |
| VOH | Output "H" voltage | Other than XOUT | Drive capacity High Vcc = 5 V | IOH = -20 mA | Vcc - 2.0 | — | Vcc | V |
| | | | Drive capacity Low Vcc = 5 V | IOH = -5 mA | Vcc - 2.0 | — | Vcc | V |
| | | XOUT | Vcc = 5 V | IOH = -200 μA | 1.0 | — | Vcc | V |
| VOL | Output "L" voltage | Other than XOUT | Drive capacity High Vcc = 5 V | IOL = 20 mA | — | — | 2.0 | V |
| | | | Drive capacity Low Vcc = 5 V | IOL = 5 mA | — | — | 2.0 | V |
| | | XOUT | Vcc = 5 V | IOL = 200 μA | — | — | 0.5 | V |
| VT+-VT- | Hysteresis | INT0, INT1, INT2, INT3, INT4, KI0, KI1, KI2, KI3, TRAIO, TRBO, TRCIOA, TRCIOB, TRCIOC, TRCIOD, TRDIOA0, TRDIOB0, TRDIOC0, TRDIOD0, TRDIOA1, TRDIOB1, TRDIOC1, TRDIOD1, TRCTRG, TRCCLK, ADTRG, RXD0, RXD1, RXD2, CLK0, CLK1, CLK2, SSI, SCL, SDA, SSO | | | 0.1 | 1.2 | — | V |
| | | RESET | | | 0.1 | 1.2 | — | V |
| IiH | Input "H" current | | VI = 5 V, Vcc = 5.0 V | | — | — | 5.0 | μA |
| IiL | Input "L" current | | VI = 0 V, Vcc = 5.0 V | | — | — | -5.0 | μA |
| RPULLUP | Pull-up resistance | | VI = 0 V, Vcc = 5.0 V | | 25 | 50 | 100 | kΩ |
| RfXIN | Feedback resistance | XIN | | | — | 0.3 | — | MΩ |
| RfXCIN | Feedback resistance | XCIN | | | — | 8 | — | MΩ |
| VRAM | RAM hold voltage | | During stop mode | | 1.8 | — | — | V |

Note:

1. 4.2 V ≤ Vcc ≤ 5.5 V and Topr = -20 to 85°C (N version) / -40 to 85°C (D version), f(XIN) = 20 MHz, unless otherwise specified.

Table 5.18 Electrical Characteristics (2) [$3.3\text{ V} \leq V_{CC} \leq 5.5\text{ V}$]
($T_{opr} = -20\text{ to }85^\circ\text{C}$ (N version) / $-40\text{ to }85^\circ\text{C}$ (D version), unless otherwise specified.)

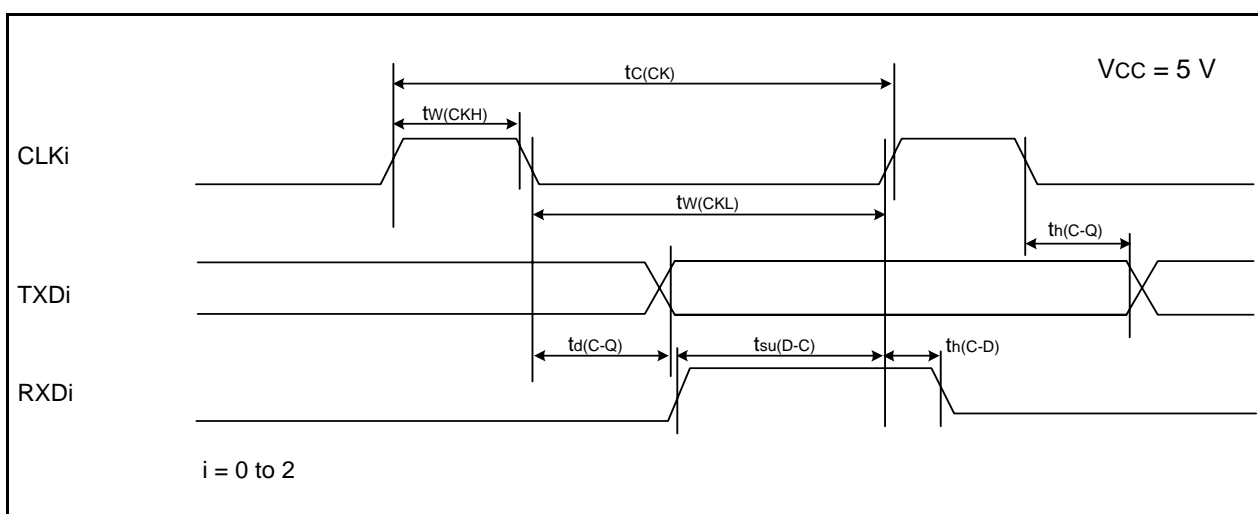
| Symbol | Parameter | Condition | | Standard | | | Unit |
|--------|---|--|--|----------|-------------------|------|------|
| | | | | Min. | Typ. | Max. | |
| Icc | Power supply current (Vcc = 3.3 to 5.5 V) Single-chip mode, output pins are open, other pins are Vss | High-speed clock mode | XIN = 20 MHz (square wave) High-speed on-chip oscillator off Low-speed on-chip oscillator on = 125 kHz No division | – | 6.5 | 15 | mA |
| | | | XIN = 16 MHz (square wave) High-speed on-chip oscillator off Low-speed on-chip oscillator on = 125 kHz No division | – | 5.3 | 12.5 | mA |
| | | | XIN = 10 MHz (square wave) High-speed on-chip oscillator off Low-speed on-chip oscillator on = 125 kHz No division | – | 3.6 | – | mA |
| | | | XIN = 20 MHz (square wave) High-speed on-chip oscillator off Low-speed on-chip oscillator on = 125 kHz Divide-by-8 | – | 3.0 | – | mA |
| | | | XIN = 16 MHz (square wave) High-speed on-chip oscillator off Low-speed on-chip oscillator on = 125 kHz Divide-by-8 | – | 2.2 | – | mA |
| | | | XIN = 10 MHz (square wave) High-speed on-chip oscillator off Low-speed on-chip oscillator on = 125 kHz Divide-by-8 | – | 1.5 | – | mA |
| | | High-speed on-chip oscillator mode | XIN clock off High-speed on-chip oscillator on fOCO-F = 20 MHz Low-speed on-chip oscillator on = 125 kHz No division | – | 7.0 | 15 | mA |
| | | | XIN clock off High-speed on-chip oscillator on fOCO-F = 20 MHz Low-speed on-chip oscillator on = 125 kHz Divide-by-8 | – | 3.0 | – | mA |
| | | | XIN clock off High-speed on-chip oscillator on fOCO-F = 4 MHz Low-speed on-chip oscillator on = 125 kHz Divide-by-16, MSTIC = MSTTRD = MSTTRC = 1 | – | 1 | – | mA |
| | | Low-speed on-chip oscillator mode | XIN clock off High-speed on-chip oscillator off Low-speed on-chip oscillator on = 125 kHz Divide-by-8, FMR27 = 1, VCA20 = 0 | – | 90 | 400 | μA |
| | | Low-speed clock mode | XIN clock off High-speed on-chip oscillator off Low-speed on-chip oscillator off XCIN clock oscillator on = 32 kHz No division, FMR27 = 1, VCA20 = 0 | – | 85 | 400 | μA |
| | | | XIN clock off High-speed on-chip oscillator off Low-speed on-chip oscillator off XCIN clock oscillator on = 32 kHz No division, Program operation on RAM Flash memory off, FMSTP = 1, VCA20 = 0 | – | 47 | – | μA |
| | | Wait mode | XIN clock off High-speed on-chip oscillator off Low-speed on-chip oscillator on = 125 kHz While a WAIT instruction is executed Peripheral clock operation VCA27 = VCA26 = VCA25 = 0 VCA20 = 1 | – | 15 | 100 | μA |
| | | | XIN clock off High-speed on-chip oscillator off Low-speed on-chip oscillator on = 125 kHz While a WAIT instruction is executed Peripheral clock off VCA27 = VCA26 = VCA25 = 0 VCA20 = 1 | – | 4 | 90 | μA |
| | | | XIN clock off High-speed on-chip oscillator off Low-speed on-chip oscillator off XCIN clock oscillator on = 32 kHz (peripheral clock off) While a WAIT instruction is executed VCA27 = VCA26 = VCA25 = 0 VCA20 = 1 | – | 3.5 | – | μA |
| | | Stop mode | XIN clock off, Topr = 25°C High-speed on-chip oscillator off Low-speed on-chip oscillator off CM10 = 1, Peripheral clock off VCA27 = VCA26 = VCA25 = 0 | – | 2.0 | 5.0 | μA |
| | | | XIN clock off, Topr = 85°C High-speed on-chip oscillator off Low-speed on-chip oscillator off CM10 = 1, Peripheral clock off VCA27 = VCA26 = VCA25 = 0 | – | 5.0 (1) 15 (2) | – | μA |

Notes:

- Value when the program ROM capacity of the product is 16 Kbytes to 32 Kbytes.
- Value when the program ROM capacity of the product is 48 Kbytes to 128 Kbytes.

Table 5.21 Serial Interface

| Symbol | Parameter | Standard | | Unit |
|---------------|------------------------|----------|------|------|
| | | Min. | Max. | |
| $t_{c(CK)}$ | CLKi input cycle time | 200 | — | ns |
| $t_{w(CKH)}$ | CLKi input "H" width | 100 | — | ns |
| $t_{w(CKL)}$ | CLKi input "L" width | 100 | — | ns |
| $t_{d(C-Q)}$ | TXDi output delay time | — | 50 | ns |
| $t_{h(C-Q)}$ | TXDi hold time | 0 | — | ns |
| $t_{su(D-C)}$ | RXDi input setup time | 50 | — | ns |
| $t_{h(C-D)}$ | RXDi input hold time | 90 | — | ns |

 $i = 0 \text{ to } 2$ **Figure 5.10 Serial Interface Timing Diagram when Vcc = 5 V****Table 5.22 External Interrupt \overline{INTi} ($i = 0 \text{ to } 4$) Input, Key Input Interrupt \overline{Kli} ($i = 0 \text{ to } 3$)**

| Symbol | Parameter | Standard | | Unit |
|--------------|---|----------|------|------|
| | | Min. | Max. | |
| $t_{w(INH)}$ | \overline{INTi} input "H" width, \overline{Kli} input "H" width | 250 (1) | — | ns |
| $t_{w(INL)}$ | \overline{INTi} input "L" width, \overline{Kli} input "L" width | 250 (2) | — | ns |

Notes:

1. When selecting the digital filter by the \overline{INTi} input filter select bit, use an \overline{INTi} input HIGH width of either (1/digital filter clock frequency $\times 3$) or the minimum value of standard, whichever is greater.
2. When selecting the digital filter by the \overline{INTi} input filter select bit, use an \overline{INTi} input LOW width of either (1/digital filter clock frequency $\times 3$) or the minimum value of standard, whichever is greater.

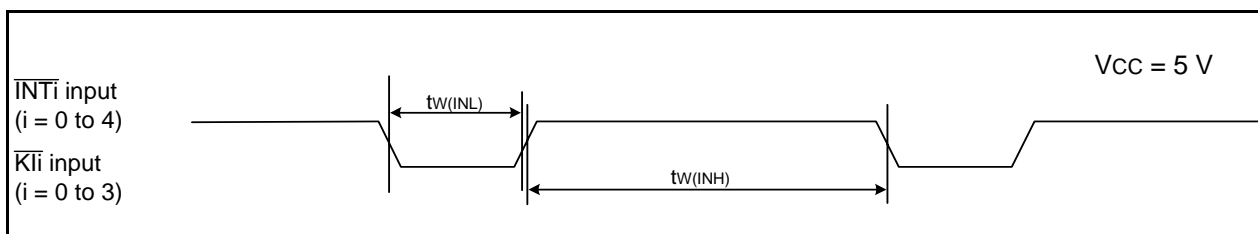
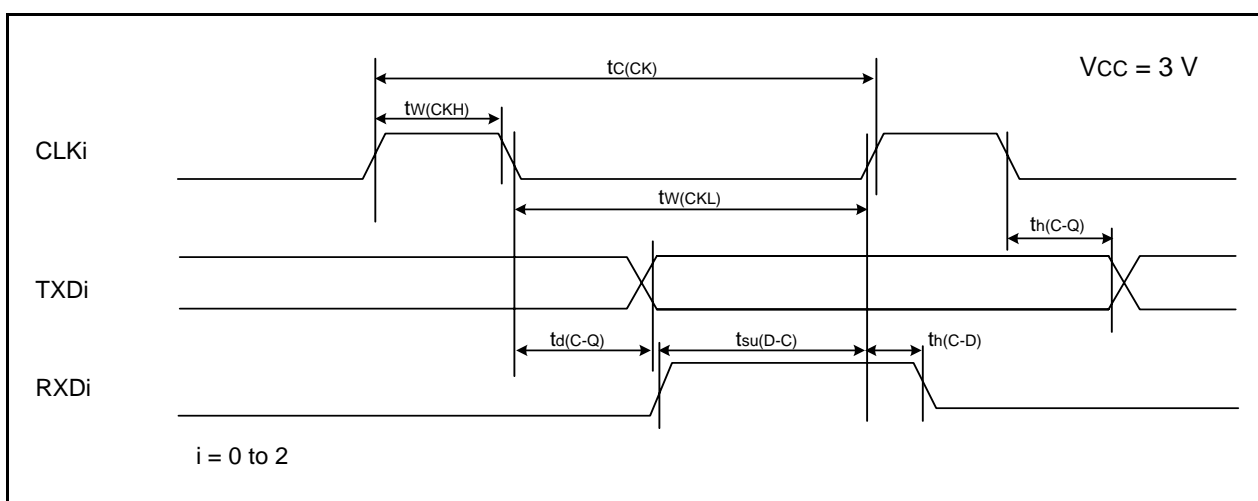
**Figure 5.11 Input Timing Diagram for External Interrupt \overline{INTi} and Key Input Interrupt \overline{Kli} when Vcc = 5 V**

Table 5.27 Serial Interface

| Symbol | Parameter | Standard | | Unit |
|---------------|------------------------|----------|------|------|
| | | Min. | Max. | |
| $t_{c(CK)}$ | CLKi input cycle time | 300 | — | ns |
| $t_{w(CKH)}$ | CLKi input "H" width | 150 | — | ns |
| $t_{w(CKL)}$ | CLKi Input "L" width | 150 | — | ns |
| $t_{d(C-Q)}$ | TXDi output delay time | — | 80 | ns |
| $t_{h(C-Q)}$ | TXDi hold time | 0 | — | ns |
| $t_{su(D-C)}$ | RXDi input setup time | 70 | — | ns |
| $t_{h(C-D)}$ | RXDi input hold time | 90 | — | ns |

i = 0 to 2

**Figure 5.14 Serial Interface Timing Diagram when Vcc = 3 V****Table 5.28 External Interrupt \overline{INTi} (i = 0 to 4) Input, Key Input Interrupt \overline{Kli} (i = 0 to 3)**

| Symbol | Parameter | Standard | | Unit |
|--------------|---|----------|------|------|
| | | Min. | Max. | |
| $t_{w(INH)}$ | \overline{INTi} input "H" width, \overline{Kli} input "H" width | 380 (1) | — | ns |
| $t_{w(INL)}$ | \overline{INTi} input "L" width, \overline{Kli} input "L" width | 380 (2) | — | ns |

Notes:

1. When selecting the digital filter by the \overline{INTi} input filter select bit, use an \overline{INTi} input HIGH width of either (1/digital filter clock frequency \times 3) or the minimum value of standard, whichever is greater.
2. When selecting the digital filter by the \overline{INTi} input filter select bit, use an \overline{INTi} input LOW width of either (1/digital filter clock frequency \times 3) or the minimum value of standard, whichever is greater.

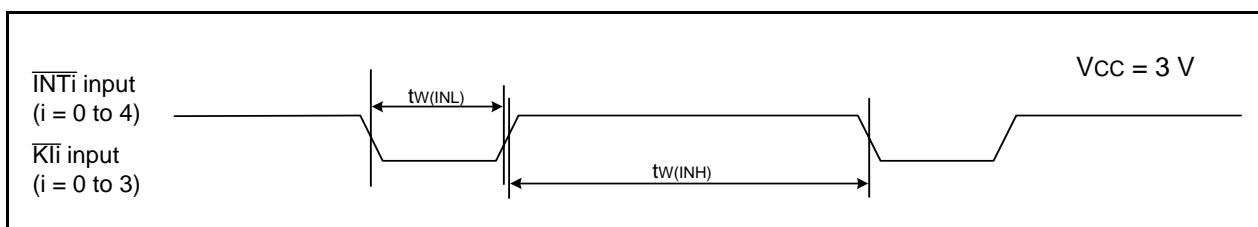
**Figure 5.15 Input Timing Diagram for External Interrupt \overline{INTi} and Key Input Interrupt \overline{Kli} when Vcc = 3 V**

Table 5.30 Electrical Characteristics (6) [$1.8\text{ V} \leq V_{CC} < 2.7\text{ V}$]
($T_{opr} = -20\text{ to }85^{\circ}\text{C}$ (N version) / $-40\text{ to }85^{\circ}\text{C}$ (D version), unless otherwise specified.)

| Symbol | Parameter | Condition | Standard | | | Unit |
|-----------------|---|---|----------|---------|------|------|
| | | | Min. | Typ. | Max. | |
| I _{CC} | Power supply current ($V_{CC} = 1.8\text{ to }2.7\text{ V}$) Single-chip mode, output pins are open, other pins are V _{SS} | High-speed clock mode | – | 2.2 | – | mA |
| | | | | 0.8 | – | |
| | | High-speed on-chip oscillator mode | – | 2.5 | 10 | mA |
| | | | | 1.7 | – | |
| | | | | 1 | – | |
| | | | | – | – | |
| | | Low-speed on-chip oscillator mode | – | 90 | 300 | μA |
| | | | | 80 | 350 | |
| | | Low-speed clock mode | – | 40 | – | μA |
| | | | | – | – | |
| | | Wait mode | – | 15 | 90 | μA |
| | | | | 4 | 80 | |
| | | | | 3.5 | – | |
| | | | | – | – | |
| | | Stop mode | – | 2.0 | 5 | μA |
| | | | | 5.0 (1) | – | |
| | | Stop mode | – | 15 (2) | – | μA |
| | | | | – | – | |

Notes:

- Value when the program ROM capacity of the product is 16 Kbytes to 32 Kbytes.
- Value when the program ROM capacity of the product is 48 Kbytes to 128 Kbytes.

General Precautions in the Handling of MPU/MCU Products

The following usage notes are applicable to all MPU/MCU products from Renesas. For detailed usage notes on the products covered by this manual, refer to the relevant sections of the manual. If the descriptions under General Precautions in the Handling of MPU/MCU Products and in the body of the manual differ from each other, the description in the body of the manual takes precedence.

1. Handling of Unused Pins

Handle unused pins in accord with the directions given under Handling of Unused Pins in the manual.

- The input pins of CMOS products are generally in the high-impedance state. In operation with an unused pin in the open-circuit state, extra electromagnetic noise is induced in the vicinity of LSI, an associated shoot-through current flows internally, and malfunctions occur due to the false recognition of the pin state as an input signal become possible. Unused pins should be handled as described under Handling of Unused Pins in the manual.

2. Processing at Power-on

The state of the product is undefined at the moment when power is supplied.

- The states of internal circuits in the LSI are indeterminate and the states of register settings and pins are undefined at the moment when power is supplied.

In a finished product where the reset signal is applied to the external reset pin, the states of pins are not guaranteed from the moment when power is supplied until the reset process is completed.

In a similar way, the states of pins in a product that is reset by an on-chip power-on reset function are not guaranteed from the moment when power is supplied until the power reaches the level at which resetting has been specified.

3. Prohibition of Access to Reserved Addresses

Access to reserved addresses is prohibited.

- The reserved addresses are provided for the possible future expansion of functions. Do not access these addresses; the correct operation of LSI is not guaranteed if they are accessed.

4. Clock Signals

After applying a reset, only release the reset line after the operating clock signal has become stable. When switching the clock signal during program execution, wait until the target clock signal has stabilized.

- When the clock signal is generated with an external resonator (or from an external oscillator) during a reset, ensure that the reset line is only released after full stabilization of the clock signal. Moreover, when switching to a clock signal produced with an external resonator (or by an external oscillator) while program execution is in progress, wait until the target clock signal is stable.

5. Differences between Products

Before changing from one product to another, i.e. to one with a different part number, confirm that the change will not lead to problems.

- The characteristics of MPU/MCU in the same group but having different part numbers may differ because of the differences in internal memory capacity and layout pattern. When changing to products of different part numbers, implement a system-evaluation test for each of the products.